

## BUCK CURRENT/VOLTAGE FED PUSH-PULL PWM CONTROLLERS

Check for Samples: [UC2827-1](#), [UC2827-2](#), [UC3827-1](#), [UC3827-2](#)

### FEATURES

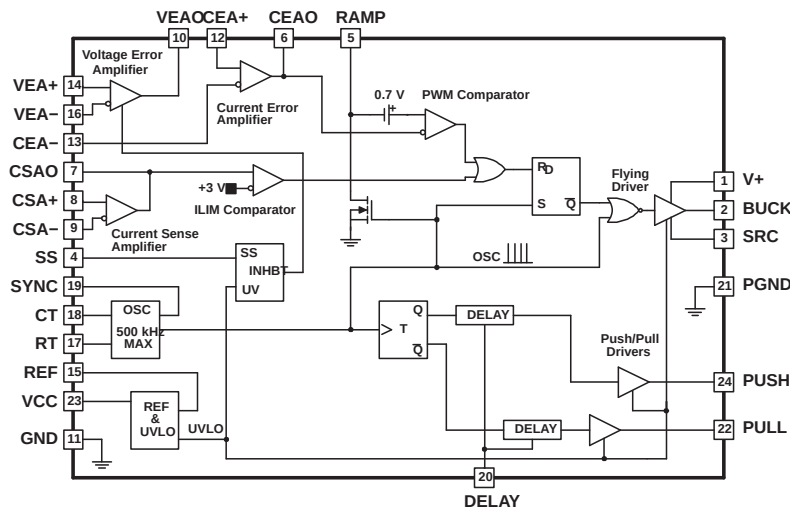
- Ideal for Multiple Output and/or High Voltage Output Voltage Converters
- Up to 500 kHz Operation
- High Voltage, High Current Floating Driver for Buck Converter Stage
- UC3827-1 Current Fed Controller has Push-Pull Drivers with Overlapping Conduction Periods
- UC3827-2 Voltage Fed Controller has Push-Pull Drivers with Nonoverlapping Conduction Periods
- Average Current Mode, Peak Current Mode or Voltage Mode with Input Voltage Feedforward Control for Buck Power Stage
- Wide Bandwidth, Low Offset, Differential Current Sense Amplifier
- Precise Short Circuit Current Control

### DESCRIPTION

The UC3827 family of controller devices provides an integrated control solution for cascaded buck and push-pull converters. These converters are known as current fed or voltage fed push-pull converters and are ideally suited for multiple output and/or high voltage output applications. In both current fed and voltage fed modes, the push-pull switches are driven at 50% nominal duty cycles and at one half the switching frequency of the buck stage. In the current fed mode, the two switches are driven with a specified over-lap period to prevent ringing and voltage stress on the devices. In the voltage fed mode, the two switches are driven with a specified gap time between the switches to prevent shorting the transformer across the energy storage capacitor and to prohibit excessive currents flowing through the devices.

The converter's output voltage is regulated by pulse width modulation of the buck switch. The UC3827 contains complete protection and PWM control functions for the buck converter. Easy control of the floating switch is accomplished by the floating drive circuitry. The gate drive waveform is level shifted to support an input voltage up to  $72 V_{DC}$ .

### BLOCK DIAGRAM



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## DESCRIPTION (CONTINUED)

The UC3827 can be set up in traditional voltage mode control using input voltage feedforward technique or in current mode control. Using current mode control prevents potential core saturation of the push-pull transformer due to mismatches in timing and in component tolerances. With average current mode control, precise control of the inductor current feeding the push-pull stage is possible without the noise sensitivity associated with peak current mode control. The UC3827 average current mode loop can also be connected in parallel with the voltage regulation loop to assist only in fault conditions.

Other valuable features of the UC3827 include bidirectional synchronization capability, user programmable overlap time (UC3827-1), user programmable gap time (UC3827-2), a high bandwidth differential current sense amplifier, and soft start circuitry.

## ORDERING INFORMATION<sup>(1)</sup>

| $T_A = T_J$   | PUSH-PULL TOPOLOGY | PACKAGES   |           |           |
|---------------|--------------------|------------|-----------|-----------|
|               |                    | SOIC-24    | PDIP-24   | PLCC-28   |
| -40°C to 85°C | Current Fed        | UC2827DW-1 | UC2827N-1 | -         |
|               | Voltage Fed        | UC2827DW-2 | UC2827N-2 | -         |
| 0°C to 70°C   | Current Fed        | UC3827DW-1 | UC3827N-1 | UC3827Q-1 |
|               | Voltage Fed        | UC3827DW-2 | UC3827N-2 | -         |

(1) The DW and Q packages are also available taped and reeled. Add a TR suffix to the device type (i.e., UC2827DWTR-1).

## THERMAL INFORMATION

| THERMAL METRIC   |                                                          | UC2827-1,<br>UC2827-2,<br>UC3827-1,<br>UC3827-2 | UC2827-1,<br>UC2827-2,<br>UC3827-1,<br>UC3827-2 | UNITS |
|------------------|----------------------------------------------------------|-------------------------------------------------|-------------------------------------------------|-------|
|                  |                                                          | N                                               | J                                               |       |
|                  |                                                          | 24 PINS                                         | 24 PINS                                         |       |
| $\theta_{JA}$    | Junction-to-ambient thermal resistance <sup>(1)</sup>    | 60                                              | 70 to 80                                        | °C/W  |
| $\theta_{JCTop}$ | Junction-to-case (top) thermal resistance <sup>(2)</sup> | 30                                              | 28                                              |       |

- (1) The junction-to-ambient thermal resistance under natural convection is obtained in a simulation on a JEDEC-standard, high-K board, as specified in JESD51-7, in an environment described in JESD51-2a.
- (2) The junction-to-case (top) thermal resistance is obtained by simulating a cold plate test on the package top. No specific JEDEC-standard test exists, but a close description can be found in the ANSI SEMI standard G30-88.

## THERMAL INFORMATION

| THERMAL METRIC   |                                                          | UC2827-1,<br>UC2827-2,<br>UC3827-1,<br>UC3827-2 | UC2827-1,<br>UC2827-2,<br>UC3827-1,<br>UC3827-2 | UNITS |
|------------------|----------------------------------------------------------|-------------------------------------------------|-------------------------------------------------|-------|
|                  |                                                          | DW                                              | <sup>(1)</sup> QLCC                             |       |
|                  |                                                          | 28 PINS                                         | 28 PINS                                         |       |
| $\theta_{JA}$    | Junction-to-ambient thermal resistance <sup>(2)</sup>    | 71 to 83                                        | 40 to 65                                        | °C/W  |
| $\theta_{JCTop}$ | Junction-to-case (top) thermal resistance <sup>(3)</sup> | 24                                              | 30                                              |       |

- (1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, [SPRA953](#).
- (2) The junction-to-ambient thermal resistance under natural convection is obtained in a simulation on a JEDEC-standard, high-K board, as specified in JESD51-7, in an environment described in JESD51-2a.
- (3) The junction-to-case (top) thermal resistance is obtained by simulating a cold plate test on the package top. No specific JEDEC-standard test exists, but a close description can be found in the ANSI SEMI standard G30-88.

## ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

|                                      |                                                                                            | UC2827-1<br>UC2827-2<br>UC3827-1<br>UC3827-2 | UNITS |
|--------------------------------------|--------------------------------------------------------------------------------------------|----------------------------------------------|-------|
| Supply voltage, VCC                  |                                                                                            | 20                                           | V     |
| Input voltage range                  | CEAO, CEA+, CEA-, CSAO, CSA+, CSA-, CT, DELAY, PUSH, PULL, RAMP, RT, SS, SYNC, VEA+, VEOA, | –0.3 to 5                                    |       |
|                                      | V+ and BUCK                                                                                | 90                                           |       |
|                                      | SRC                                                                                        | 90-VCC                                       |       |
| BUCK driver                          | I/O continuous                                                                             | ±250                                         | mA    |
|                                      | I/O peak                                                                                   | ±1                                           | A     |
| PUSH/PULL driver                     | I/O continuous                                                                             | ±200                                         | mA    |
|                                      | I/O peak                                                                                   | ±0.8                                         | A     |
| Storage temperature                  |                                                                                            | –65 to 150                                   | °C    |
| Junction temperature                 |                                                                                            | –55 to 150                                   |       |
| Lead temperature (soldering, 10 sec) |                                                                                            | 300                                          |       |

(1) Voltages are referenced to ground. Currents are positive into, negative out of the specified terminal. Consult *Packaging* section of databook for thermal limitations and considerations of packages.

## ELECTRICAL CHARACTERISTICS

Unless otherwise specified,  $V_{VCC} = 15\text{ V}$ ,  $V_{V+} = 14.3\text{ V}$ ,  $C_{CT} = 340\text{ pF}$ ,  $R_{RT} = 10\text{ k}\Omega$ ,  $R_{DELAY} = 24.3\text{ k}\Omega$ ,  $V_{SRC} = V_{GND} = V_{BUCK} = V_{PUSH} = V_{PULL}$  outputs no load,  $T_J = T_A$

| PARAMETER                      |                                  | TEST CONDITIONS                             | MIN  | TYP  | MAX  | UNIT          |
|--------------------------------|----------------------------------|---------------------------------------------|------|------|------|---------------|
| <b>SUPPLY</b>                  |                                  |                                             |      |      |      |               |
| VCC UVLO, Turn-on              |                                  |                                             | 8.3  | 8.8  | 9.5  | V             |
| Hysteresis                     |                                  |                                             | 0.9  | 1.2  | 1.5  | V             |
| $I_{VCC}$                      | Supply current start             | $V_{VCC} = 8\text{ V}$                      |      |      | 1000 | $\mu\text{A}$ |
| $I_{VCC}$                      | Supply current run               |                                             |      | 32   | 45   | mA            |
| $I_{V+}$ buck high             |                                  |                                             | 0.2  | 1    | 2    | mA            |
| <b>VOLTAGE ERROR AMPLIFIER</b> |                                  |                                             |      |      |      |               |
| IB                             |                                  |                                             |      | 0.5  | 3    | $\mu\text{A}$ |
| VIO                            |                                  |                                             |      |      | 10   | mV            |
| AVOL                           |                                  |                                             | 80   | 95   |      | dB            |
| GBW <sup>(1)</sup>             | Gain bandwidth                   |                                             | 1    | 4    |      | MHz           |
| $V_{OL}$                       | Low-level output voltage         | $I_{VEAO} = 0\text{ }\mu\text{A}$ (No load) |      | 0.3  | 0.5  | V             |
| $V_{OH}$                       | High-level output voltage        | $I_{VEAO} = 0\text{ }\mu\text{A}$ (No load) | 2.85 | 3    | 3.20 | V             |
| <b>CURRENT SENSE AMPLIFIER</b> |                                  |                                             |      |      |      |               |
| IB                             |                                  |                                             |      | –1   | –5   | $\mu\text{A}$ |
| VIO                            |                                  |                                             |      |      | 5    | mV            |
| AVOL                           |                                  |                                             | 80   | 110  |      | dB            |
| GBW <sup>(1)</sup>             | Gain bandwidth                   |                                             | 15   | 29   |      | MHz           |
| $V_{OL}$                       | Low-level output voltage         | $I_{CEAO} = 0\text{ }\mu\text{A}$ (No load) |      | 0.25 | 0.5  | V             |
| $V_{OH}$                       | High-level output voltage        | $I_{CEAO} = 0\text{ }\mu\text{A}$ (No load) | 3    | 3.3  |      | V             |
| CMRR                           | Common mode range <sup>(1)</sup> |                                             | –0.3 |      | 2    | V             |

(1) Ensured by design. Not production tested.

**ELECTRICAL CHARACTERISTICS (continued)**

Unless otherwise specified,  $V_{VCC} = 15\text{ V}$ ,  $V_{V+} = 14.3\text{ V}$ ,  $C_{CT} = 340\text{ pF}$ ,  $R_{RT} = 10\text{ k}\Omega$ ,  $R_{DELAY} = 24.3\text{ k}\Omega$ ,  $V_{SRC} = V_{GND} = V_{BUCK} = V_{PUSH} = V_{PULL}$  outputs no load,  $T_J = T_A$

| PARAMETER                          |                                  | TEST CONDITIONS                                             | MIN                            | TYP  | MAX | UNIT |
|------------------------------------|----------------------------------|-------------------------------------------------------------|--------------------------------|------|-----|------|
| CURRENT ERROR AMPLIFIER            |                                  |                                                             |                                |      |     |      |
| IB                                 |                                  |                                                             |                                | −1   | −5  | μA   |
| VIO                                |                                  |                                                             |                                |      | 10  | mV   |
| AVOL                               |                                  |                                                             | 80                             | 110  |     | dB   |
| GBW <sup>(2)</sup>                 | Gain bandwidth                   | At 100 kHz, Measure Gain                                    | 2                              | 4.5  |     | MHz  |
| VOL                                |                                  | ICEAO = 0 μA (No Load)                                      |                                | 0.25 | 0.5 | V    |
| VOH                                |                                  | ICEAO = 0 μA (No Load)                                      | 3.3                            | 3.5  |     | V    |
| CMRR                               | Common mode range <sup>(2)</sup> |                                                             | −0.3                           |      | 5   | V    |
| OSCILLATOR SECTION                 |                                  |                                                             |                                |      |     |      |
| fOSC                               |                                  | Frequency                                                   | 180                            | 220  | 250 | kHz  |
| ICT(dsch)                          |                                  | CT discharge current                                        | 5                              |      |     | mA   |
| PWM COMPARATOR                     |                                  |                                                             |                                |      |     |      |
| D <sub>MAX</sub>                   |                                  | Minimum duty cycle                                          |                                |      | 0%  |      |
| D <sub>MAX</sub>                   |                                  | Maximum duty cycle                                          | 85%                            | 91%  | 95% |      |
| BUCK OUTPUT STAGE                  |                                  |                                                             |                                |      |     |      |
| t <sub>RISE</sub>                  |                                  | Rise time                                                   | 1 nF Load <sup>(3)</sup>       | 40   | 100 | ns   |
| t <sub>FALL</sub>                  |                                  | Fall tme                                                    | 1 nF, Load                     | 30   | 80  | ns   |
| VOH                                | High-level output voltage        | I <sub>BUCK</sub> = −15 mA , V+ −BUCK <sup>(4)</sup>        |                                | 1.5  | 2.5 | V    |
|                                    |                                  | IBUCK = −150 mA, V+ −BUCK <sup>(4)</sup>                    |                                | 2    | 2.5 | V    |
| VOL                                | Low-level output voltage         | I <sub>BUCK</sub> = 15 mA <sup>(5)</sup>                    |                                | 0.2  | 0.4 | V    |
|                                    |                                  | I <sub>BUC</sub> K = 150 mA <sup>(5)</sup>                  |                                | 0.7  | 1.2 | V    |
| PUSH/PULL OUTPUT STAGES            |                                  |                                                             |                                |      |     |      |
| t <sub>RISE</sub>                  |                                  | Rise time                                                   | 1 nF load                      | 50   | 100 | ns   |
| t <sub>FALL</sub>                  |                                  | Fall tme                                                    | 1 nF load                      | 35   | 100 | ns   |
| Overlap time                       |                                  | UCx827-1 1 nF loads <sup>(6)</sup>                          | 100                            | 250  | 400 | ns   |
| Nonoverlapping time <sup>(7)</sup> |                                  | UCx827-2                                                    | 100                            | 250  | 500 | ns   |
| VOH                                | High-level output voltage        | I <sub>PUSH/PULL</sub> = −10 mA, VCC − PUSH <sup>(8)</sup>  |                                | 2    | 3   | V    |
|                                    |                                  | I <sub>PUSH/PULL</sub> = −100 mA, VCC − PUSH <sup>(8)</sup> |                                | 2.5  | 3   | V    |
| VOL                                | Low-level output voltage         | I <sub>PUSH/PULL</sub> = 10 mA <sup>(8)</sup>               |                                | 0.2  | 0.8 | V    |
|                                    |                                  | I <sub>PUSH/PULL</sub> = 100 mA <sup>(8)</sup>              |                                | 0.6  | 1.2 | V    |
| REFERENCE                          |                                  |                                                             |                                |      |     |      |
|                                    |                                  | Reference voltage                                           | 4.8                            | 5    | 5.2 | V    |
| I <sub>SC</sub>                    |                                  | Shor-circuit current                                        | −35                            | −50  | −65 | mA   |
|                                    |                                  | Line regulation                                             | 0.5V < V <sub>VCC</sub> < 20 V | 5    | 20  | mV   |
|                                    |                                  | Load regulation                                             | 0 mA < I <sub>IO</sub> < 10 mA | 8    | 20  | mV   |
| SOFT START                         |                                  |                                                             |                                |      |     |      |
| VOL                                |                                  | Low-level output voltage saturation                         | V <sub>VCC</sub> = 7 V         | 250  | 500 | mV   |
| I <sub>SS</sub>                    |                                  | Soft-start current                                          | −5                             | −12  | −25 | μA   |

(2) Ensured by design. Not production tested.

(3) Measure the rise time from when BUCK crosses 1 V until it crosses 9 V.

(4) To force BUCK high, force  $V_{CSAO} = 2.5\text{ V}$ ,  $V_{CEAO} = 2.5\text{ V}$ , a 25-k $\Omega$  pulldown resistor from RAMP to ground, and  $V_{CT} = 0.5\text{ V}$ .

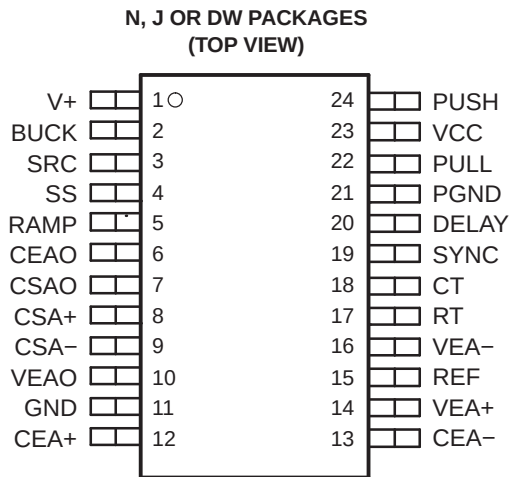
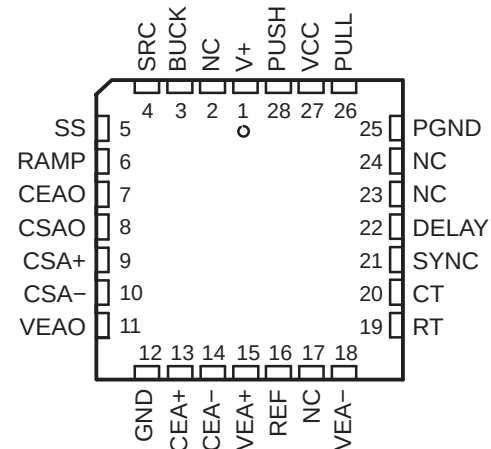
(5) To force BUCK low, force  $V_{CSAO} = 2.5\text{ V}$ ,  $V_{CEAO} = 2.5\text{ V}$ , a 10-k $\Omega$  pulldown resistor from RAMP to ground, and  $V_{CT} = 3.5\text{ V}$ .

(6) The overlap time is measured from the point at which the rising edge of PUSH/PULL crosses 5 V until the falling edge of PULL/PUSH crosses 5 V.

(7) The non-overlap time is measured from the point at which the falling edge of PUSH/PULL crosses 5 V until the rising edge of PULL/PUSH crosses 5 V.

(8) To toggle PUSH or PULL into a desired state, pulse CT from 0.5 V to 3.5 V. PUSH and PULL toggle on the rising edge of CT.

## CONNECTION DIAGRAMS

**DIL-24 (N or J, DW PACKAGES)  
(TOP VIEW)**

**PLCC-28 (Q PACKAGE)  
(TOP VIEW)**
**Q PACKAGE  
(TOP VIEW)**


NC – No internal connection

## Terminal Functions

| TERMINAL |         |    | I/O | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                                 |
|----------|---------|----|-----|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME     | N or DW | Q  |     |                                                                                                                                                                                                                                                                                                                                                                                                             |
| BUCK     | 2       | 3  | O   | Output of the buck PWM controller. The BUCK output is a floating driver, optimized for controlling the gate of an N-channel MOSFET. The peak sink and source currents are 1 A. V <sub>CC</sub> undervoltage faults disables BUCK to an off condition (low).                                                                                                                                                 |
| CEA+     | 12      | 13 | I   | Non-inverting input of the current error amplifier.                                                                                                                                                                                                                                                                                                                                                         |
| CEA-     | 13      | 14 | I   | Inverting input of the current error amplifier                                                                                                                                                                                                                                                                                                                                                              |
| CEO      | 6       | 7  | O   | Output of the current error amplifier and the inverting input of the PWM comparator of the buck converter.                                                                                                                                                                                                                                                                                                  |
| CSA+     | 8       | 9  | I   | Noninverting input of the current sense amplifier.                                                                                                                                                                                                                                                                                                                                                          |
| CSA-     | 9       | 10 | I   | Inverting input of the current sense amplifier.                                                                                                                                                                                                                                                                                                                                                             |
| CSAO     | 7       | 8  | O   | Output of the current sense amplifier and the noninverting input of the current limit comparator. When the signal level on this pin exceeds the 3V threshold of the current limit comparator, the buck gate drive pulse is terminated. This feature is useful to implement cycle-by-cycle current limiting for the buck converter.                                                                          |
| CT       | 18      | 20 | I   | Provides for the timing capacitor which is connected between CT and GND. The oscillator frequency is set by CT and a resistor RT, connected between pin RT and GND. The CT discharge current is approximately 40 x the bias current through the resistor connected to RT. A practical maximum value for the discharge current is 20 mA. The frequency of the oscillator is given by equation <sup>(1)</sup> |
| DELAY    | 20      | 22 | I   | A resistor to GND programs the overlap time of the PUSH and PULL outputs of the UC3827-1 and the dead time of the PUSH and PULL outputs of the UC3827-2. The minimum value of the resistor, R <sub>DELAY</sub> , is 18 kΩ. The delay or overlap time is given by equation <sup>(2)</sup>                                                                                                                    |
| GND      | 11      | 12 | -   | Ground reference for all sensitive setup components not related to driving the outputs. They include all timing, voltage sense, current sense, and bypass components.                                                                                                                                                                                                                                       |
| PGND     | 21      | 25 | -   | Ground connection for the PUSH and PULL outputs. PGND must be connected to GND at a single point on the printed circuit board. This is imperative to prevent large, high frequency switching currents flowing through the ground metalization inside the device.                                                                                                                                            |
| PULL     | 22      | 26 | O   | Ground referenced output to drive an N-channel MOSFET. The PULL and the PUSH outputs are driving the two switches of the push-pull converter with complementary signals at close to a 50% duty cycle. Any undervoltage faults will disable PULL to an off condition (low).                                                                                                                                  |

$$(1) \quad f_{OSC} = \frac{0.77}{R_{RT} \times C_{CT}} \quad (\text{Hz})$$

$$(2) \quad t_{DELAY} = \frac{R_{DELAY}}{200\Omega} \times 10^{-9} \quad (\text{s})$$

### Terminal Functions (continued)

| TERMINAL |         |    | I/O | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|----------|---------|----|-----|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME     | N or DW | Q  |     |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| PUSH     | 24      | 28 | O   | Ground referenced output to drive an N-channel MOSFET. The PULL and the PUSH outputs are driving the two switches of the push-pull converter with complementary signals at close to a 50% duty cycle. Any undervoltage faults disables PUSH to an off condition (low).                                                                                                                                                                                                                                                                                                                                          |
| RAMP     | 5       | 6  | I   | The RAMP voltage, after a 700 mV internal level shift, is fed to the noninverting input of the buck PWM comparator. A resistor to $V_{IN}$ and a capacitor to GND provide an input voltage feedforward signal for the buck controller in voltage mode control. In peak current mode control, the RAMP pin receives the current signal of the buck converter. In an average current mode setup, the RAMP pin has a linearly increasing ramp signal. This waveform may be generated either by connecting RAMP directly to CT, or by connecting both a resistor from VCC to RAMP and a capacitor from RAMP to GND. |
| REF      | 15      | 16 | O   | The output of the +5V on board reference. Bypass this pin with a capacitor to GND. The reference is off when the chip is in undervoltage lockout mode.                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| RT       | 17      | 19 | I   | A resistor to GND programs the charge current of the timing capacitor connected to CT. The charge current approximately equals that shown in equation <sup>(3)</sup> . The charge current should be less than 500 $\mu$ A to keep CT's discharge peak current less than 20 mA, which is CT's maximum practical discharge value. The discharge time, which sets the maximum duty cycle, is set internally and is influenced by the charge current.                                                                                                                                                               |
| SRC      | 3       | 4  | I   | The source connection for the floating buck switch. The voltage on the SRC pin can exceed VCC but must be lower than $90 V - V_{VCC}$ . Also, during turn-off transients of the buck switch, the voltage at SRC can go to $-2V$ .                                                                                                                                                                                                                                                                                                                                                                               |
| SS       | 4       | 5  | O   | Soft-start pin requires a capacitor to GND. During soft-start the output of the voltage error amplifier is clamped to the soft-start capacitor voltage which is slowly charged by an internal current source. In UVLO, SS is held low.                                                                                                                                                                                                                                                                                                                                                                          |
| SYNC     | 19      | 21 | I   | A bidirectional pin for the oscillator, used to synchronize several chips to the fastest oscillator. Its input synchronization threshold is 1.4 V. The SYNC voltage is 3.6 V when the oscillator capacitor, CT, is discharged. Otherwise it is 0 V. If the recommended synchronization circuit is not used, a 1 k $\Omega$ or lower value resistor from SYNC to GND may be needed to increase the fall time of the signal at SYNC.                                                                                                                                                                              |
| VCC      | 23      | 27 | I   | A voltage source connected to this pin supplies the power for the UC3827. It is recommended to bypass this pin to both GND and PGND ground connections with good quality high frequency capacitors                                                                                                                                                                                                                                                                                                                                                                                                              |
| VEA+     | 14      | 15 | I   | Non-inverting input of the voltage error amplifier                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| VEA-     | 16      | 18 | I   | Inverting input of the voltage error amplifier                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| VEAO     | 10      | 11 | O   | Output of the voltage error amplifier                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| V+       | 1       | 1  | I   | Supply voltage for the buck output. The floating driver of the UC3827 uses the bootstrap technique which requires a reservoir capacitor to store the required energy for the on time of the buck switch. A diode must be connected from VCC to V+ to charge the reservoir capacitor. This diode must be able to withstand $V_{IN}$ . The reservoir capacitor must be connected between V+ and SRC.                                                                                                                                                                                                              |

(3) 
$$I_{RT} = \frac{2.5 V}{R_{RT}}$$

## APPLICATION INFORMATION

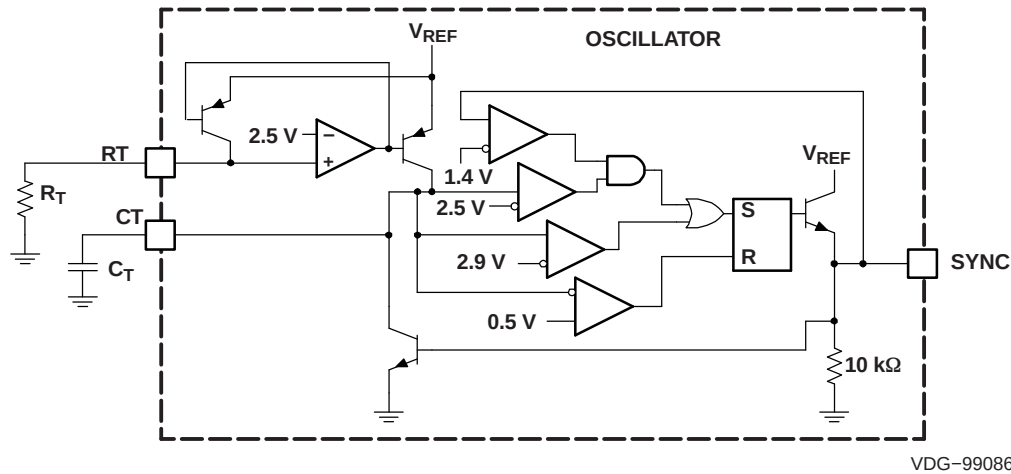


Figure 1. Oscillator Block With External Connections

## CIRCUIT BLOCK DESCRIPTION

### PWM Oscillator

The oscillator block diagram with external connections is shown in Equation 1. A resistor ( $R_T$ ) connected to pin  $RT$  sets the linear charge current:

$$I_{RT} = \frac{2.5 \text{ V}}{R_{RT}} \quad (1)$$

The timing capacitor ( $C_T$ ) is linearly charged with the charge current forcing the OSC pin to charge to a 3.4 V threshold. After exceeding this threshold, the RS flip-flop is set driving  $CLKSYN$  high and  $R_{DEAD}$  low which discharges  $C_T$ .  $C_T$  continues to discharge until it reaches a 0.5 V threshold and resets the RS flip-flop which repeats the charging sequence as shown in Figure 2

As shown in Figure 3, several oscillators are synchronized to the highest free running frequency by connecting 100 pF capacitors in series with each  $CLKSYN$  pin and connecting the other side of the capacitors together forming the  $CLKSYN$  bus. The  $CLKSYN$  bus is then pulled down to ground with a resistance of approximately 10k. Referring to Figure 1, the synchronization threshold is 1.4 V. The oscillator blanks any synchronization pulse that occurs when OSC is below 2.5 V. This allows units, once they discharge below 2.5 V, to continue through the current discharge and subsequent charge cycles whether or not other units on the  $CLKSYN$  bus are still synchronizing. This requires the frequency of all free running oscillators to be within 17% of each other to assure synchronization.

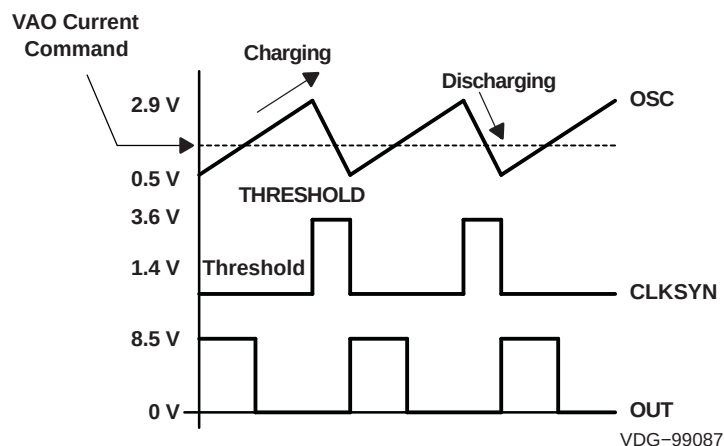


Figure 2. Oscillator and PWM Output Waveform

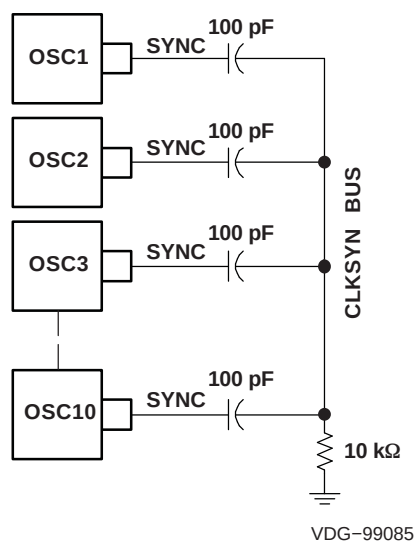


Figure 3. Oscillator Synchronization Connection Diagram

## REVISION HISTORY

| REVISION | DATE OF CHANGE | DESCRIPTION                                                                                                    |
|----------|----------------|----------------------------------------------------------------------------------------------------------------|
| SLUS365A | 8/2005         | Improved CMRR of CSA from ( 0 - 2 V) to ( -0.3 - 2 V)<br>Improved CMRR of CEA from ( 0 - 5 V) to ( -0.3 - 5 V) |
| SLUS365D | 4/2011         | Updated the Thermal Information Section                                                                        |



## PACKAGING INFORMATION

| Orderable part number        | Status<br>(1) | Material type<br>(2) | Package   Pins | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">UC2827DW-1</a>   | NRND          | Production           | SOIC (DW)   24 | 25   TUBE             | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | UC2827DW-1          |
| UC2827DW-1.A                 | NRND          | Production           | SOIC (DW)   24 | 25   TUBE             | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | UC2827DW-1          |
| <a href="#">UC2827DW-2</a>   | Obsolete      | Production           | SOIC (DW)   24 | -                     | -           | Call TI                              | Call TI                           | -40 to 85    | UC2827DW-2          |
| <a href="#">UC2827DWTR-1</a> | NRND          | Production           | SOIC (DW)   24 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | UC2827DW-1          |
| UC2827DWTR-1.A               | NRND          | Production           | SOIC (DW)   24 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | UC2827DW-1          |
| UC2827DWTR-1G4               | NRND          | Production           | SOIC (DW)   24 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-3-260C-168 HR               | -40 to 85    | UC2827DW-1          |
| <a href="#">UC3827DW-1</a>   | NRND          | Production           | SOIC (DW)   24 | 25   TUBE             | Yes         | NIPDAU                               | Level-3-260C-168 HR               | 0 to 70      | UC3827DW-1          |
| UC3827DW-1.A                 | NRND          | Production           | SOIC (DW)   24 | 25   TUBE             | Yes         | NIPDAU                               | Level-3-260C-168 HR               | 0 to 70      | UC3827DW-1          |
| <a href="#">UC3827DW-2</a>   | Obsolete      | Production           | SOIC (DW)   24 | -                     | -           | Call TI                              | Call TI                           | 0 to 70      | UC3827DW-2          |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

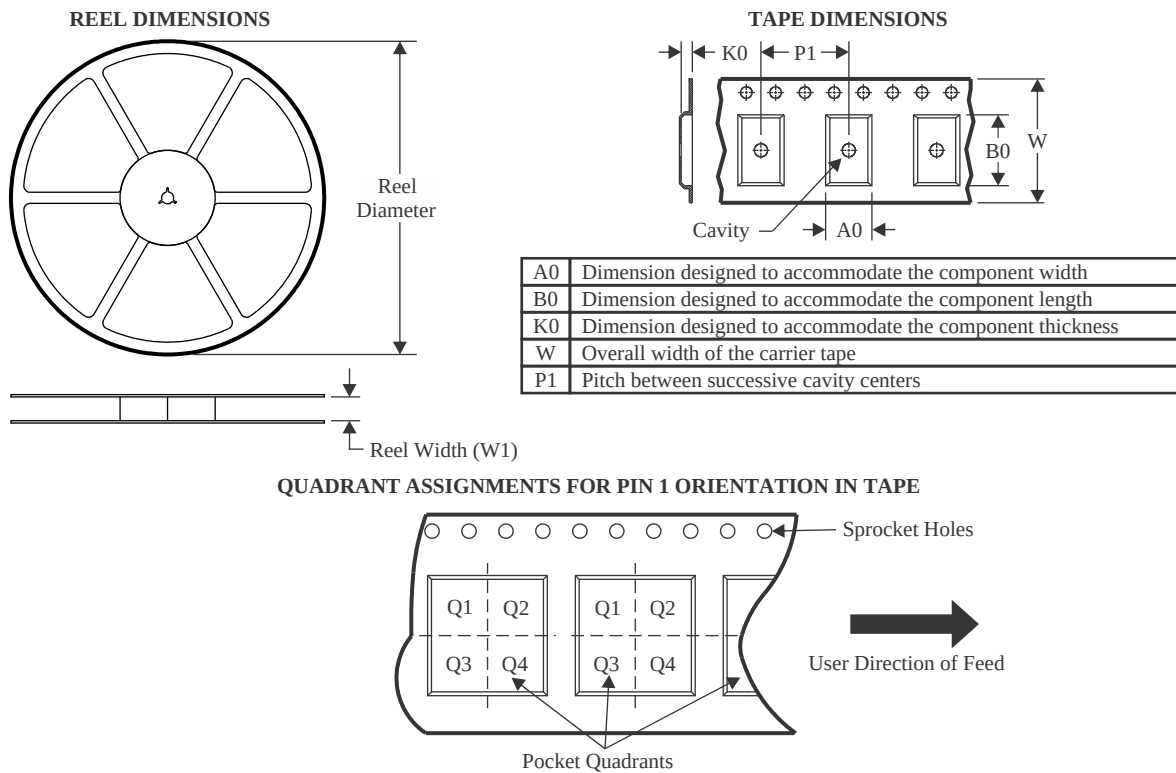
Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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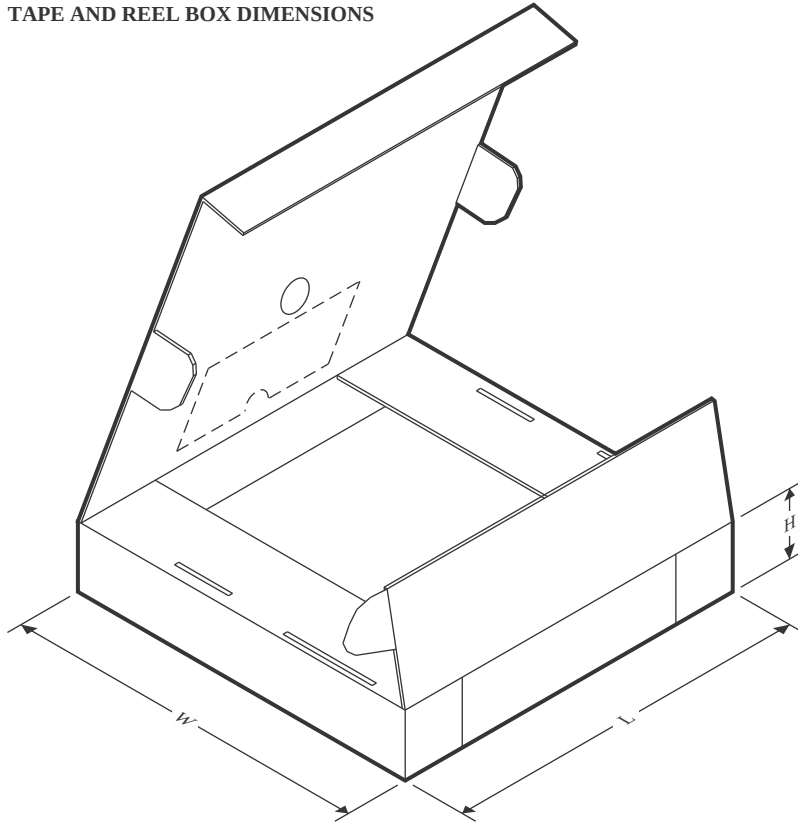
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| UC2827DWTR-1 | SOIC         | DW              | 24   | 2000 | 330.0              | 24.4               | 10.75   | 15.7    | 2.7     | 12.0    | 24.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| UC2827DWTR-1 | SOIC         | DW              | 24   | 2000 | 356.0       | 356.0      | 45.0        |

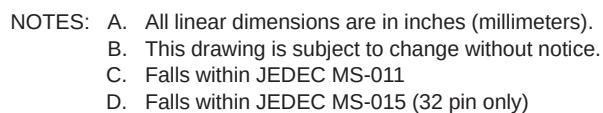
## TUBE



\*All dimensions are nominal

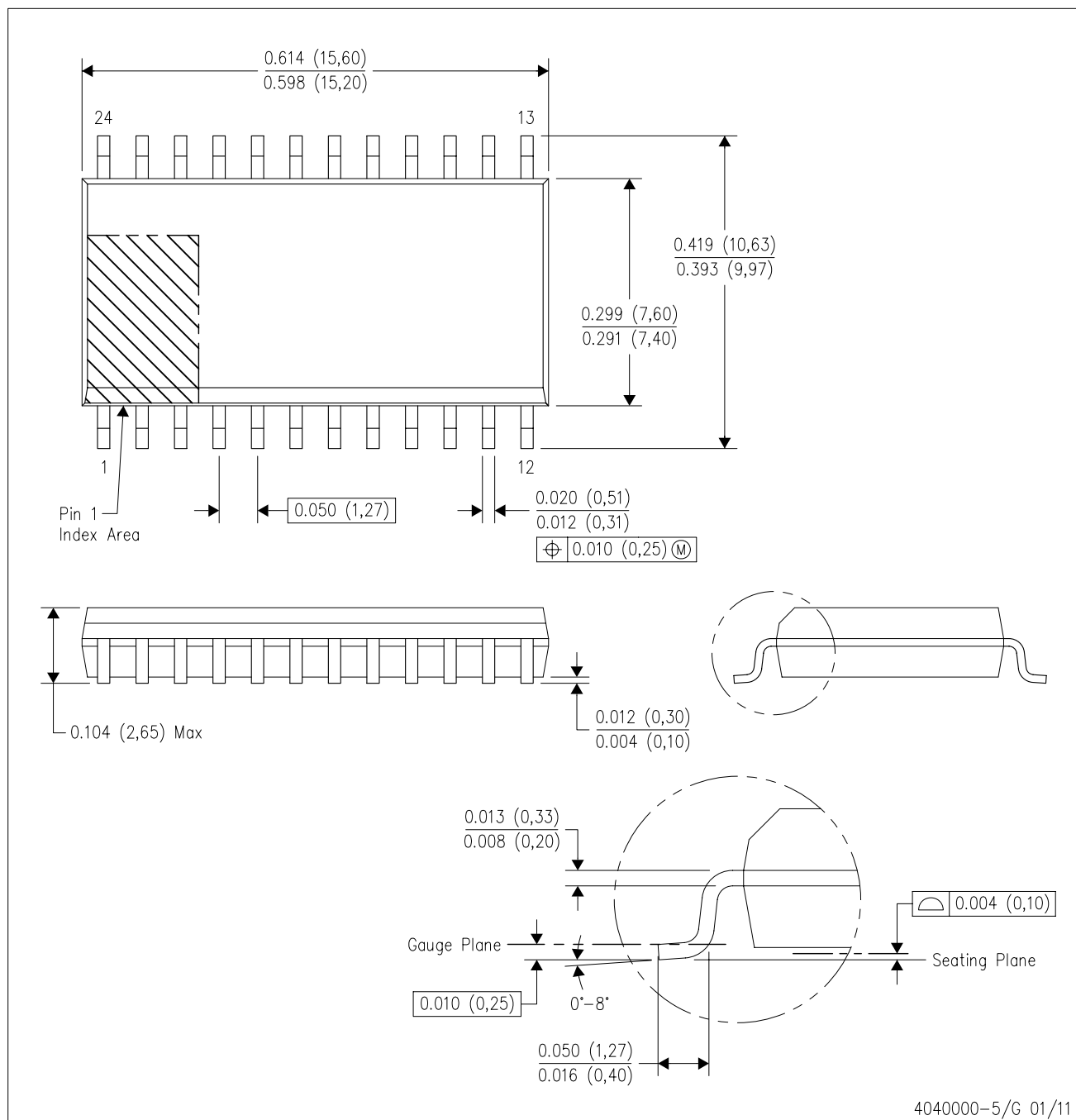
| Device       | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|--------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| UC2827DW-1   | DW           | SOIC         | 24   | 25  | 507    | 12.83  | 5080   | 6.6    |
| UC2827DW-1.A | DW           | SOIC         | 24   | 25  | 507    | 12.83  | 5080   | 6.6    |
| UC3827DW-1   | DW           | SOIC         | 24   | 25  | 507    | 12.83  | 5080   | 6.6    |
| UC3827DW-1.A | DW           | SOIC         | 24   | 25  | 507    | 12.83  | 5080   | 6.6    |

**24 PIN SHOWN**



DW (R-PDSO-G24)

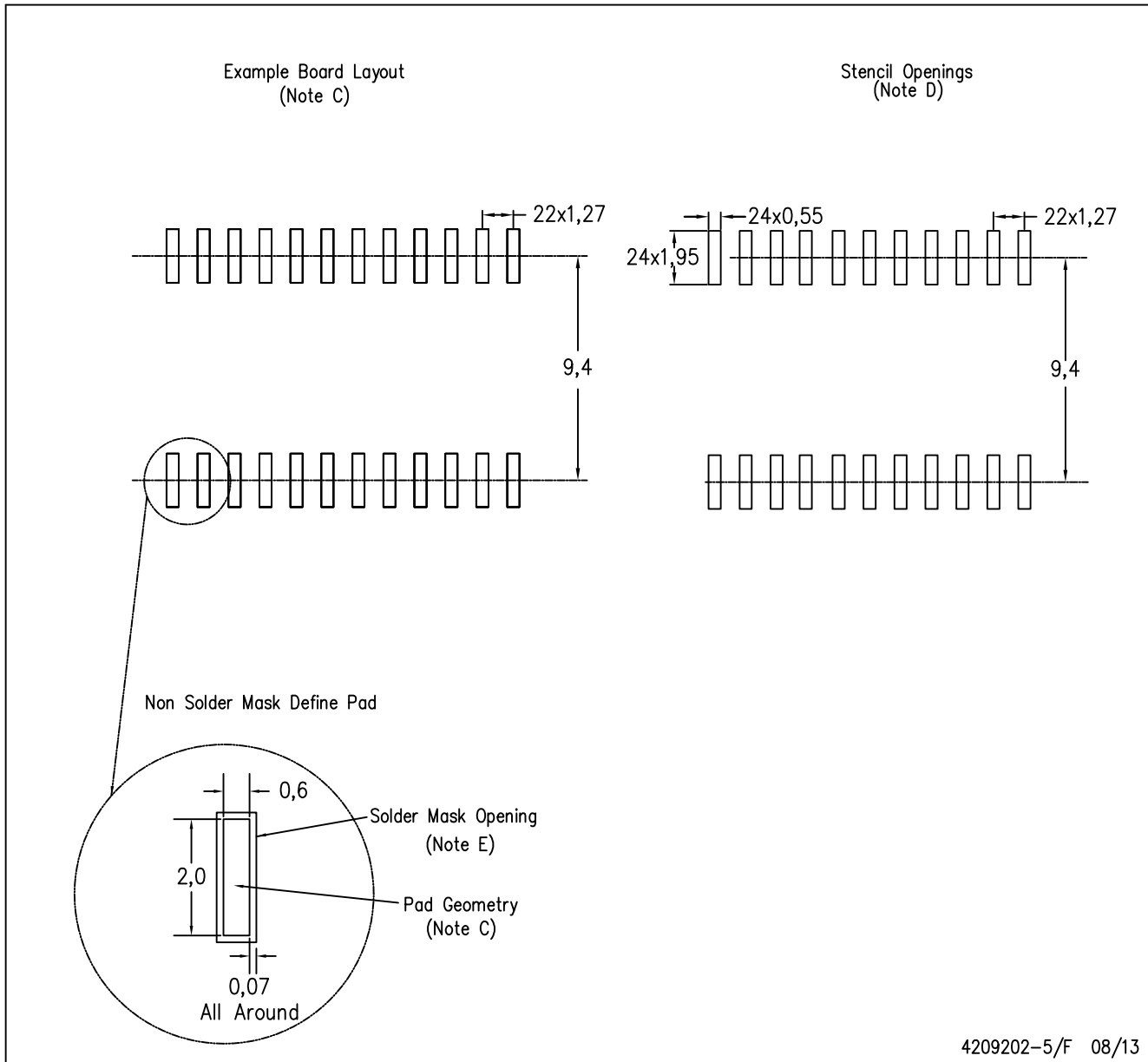
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - D. Falls within JEDEC MS-013 variation AD.

DW (R-PDSO-G24)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Refer to IPC7351 for alternate board design.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



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